

Technical Information Manual

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MOD. V 791
32 CH. ICARUS
ANALOG BOARD

NPO:
00100/98:V791x.MUTx/02

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1. General description

1.1. Overview

The CAEN Model V791 is a 32-channel analog board designed for optimum performance as front-end electronics for the ICARUS experiment (see, for example, the web site: www.aquila.infn.it:80/icarus/). Its function is to digitize the signals coming from the detector and transmit them via a fast serial link. The V791 module can be adapted to any detector which uses a charge (or current) preamplifier in Radeka configuration (folded cascode). For further details about how to adapt the module, please contact the factory directly.

A functional block of the V791 module is shown in Fig. 2.1. The 32 input signals are sent to 32 low-noise preamplifiers and relevant shapers. The processed signals are then multiplexed and digitized in order to be transmitted via the serial link.

The section for the signal digitization consists of four 8-channel blocks. Each block is made of two 4-channel analog multiplexers and a 20 MHz ADC. Each channel is sampled at a 2.5 Ms/s rate and digitized with a 10-bit resolution by using a time division multiplexing technique. The maximum delay between the sampling of a channel and the following one is 400 ns.

The Model V791 is housed in a 1-unit wide, 6-unit high Eurocard mechanics with special shielding for the protection of the low-noise circuits.

The module hosts four external connectors:

- a 64-pin input connector (rear panel),
- a 30-pin power supply and auxiliary signal connector (rear panel),
- a serial link connector (front panel),
- a Σ out connector (front panel).

Please note that, although the module is housed in a Eurocard standard mechanics, the rear connectors are not VME standard connectors since the backplane for which the board has been designed is proprietary.

Two different versions are available, specifically the **Mod. V791C** and the **Mod. V791Q** which, respectively, allow for the digitalisation of the input current and the digitalisation of the input charge. These two versions differ only for the values of the components mounted near the preamplifiers and the shapers. The main technical specifications of both versions are reported in Table 1.1.

1.2. Main technical specifications

Table 1.1 - Model V791C and Model V791Q main technical specifications

Parameter	Mod. V791C	Mod. V791Q
Number of channels	32	32
Resolution	10 bits	10 bits
Sampling frequency	2.5 MHz	2.5 MHz
Input sensitivity	10 ± 10% count/nA	3.3 ± 10% count/fC
Input signals	1 nA x 3 µs	±3 fC
Output data	10-bit double data, 40MHz	10-bit double data, 40MHz
Noise (RMS)	< 2 LSB (*)	< 2 LSB (*)
S/N (charge)	> 10	> 6
Input range	100 ± 10% nA	300 ± 10% fC
Test pulse input range	± 2.5 Vpp	± 2.5 Vpp
Sampling rate	400 ns/channel	400 ns/channel
Preamp. Transconductance	5.6 MΩ // 0.15 pF	100 MΩ // 0.5 pF
Preamplifier time constant	1 µs	50 µs
First shaper time constant	1 µs	0.27 µs
Second shaper time constant	1 µs	-
First adder time constant	1 µs	1 µs
Second adder time constant	1 µs	1 µs
Adder sensitivity (DC)	1 mV/count	1 mV/count
Offset (count)	± 10 (external setting)	± 10 (external setting)
Crosstalk (dB)	< -40 dB	< -40 dB

(*) Noise measured @ Detector Capacitance = 400 pF.

2. Functional description

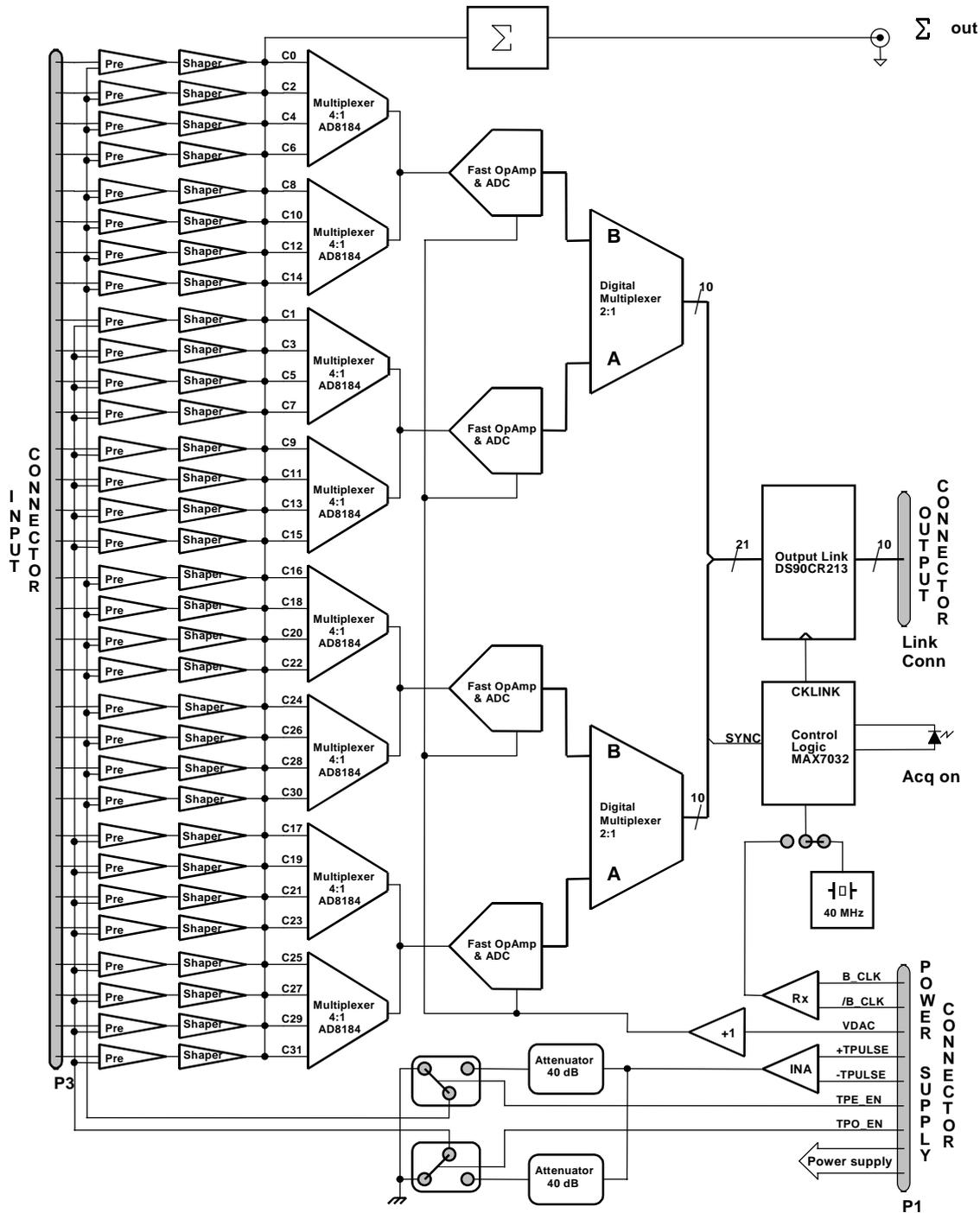


Fig. 2.1 - Block diagram of the Model V791

Fig. 2.1 shows a detailed block diagram of the V791 module.

The first section, constituted by the preamplifiers and the shapers, provides the conversion from current to voltage of the input signals and their shaping. The current signals coming from the detector are converted into voltage signals by the preamplifiers. These are constituted by two JFET followed by an ASIC specially developed by CAEN Microelectronics. The output voltage signals are then sent to the shapers having two 1- μ sec time constants or one 0.27- μ sec time constant for the Mod. V791C and Mod. V791Q, respectively. In order to allow a check of the channel operation the preamplifiers have a test input coupled through a 1-pF capacitor.

The signals coming out the shapers are sent to the input of the analog multiplexers in such an order as to keep the same signal sequence of the input connector. Moreover, the Σ out output connector on the front panel provides the sum of all the shaper outputs.

The second section is constituted by four blocks, each controlling 8 channels. Each block comprehends two analog multiplexers, a fast operational amplifier and an ADC which is connected to the input of the digital multiplexer. The 8-channel block connected to the input A of the digital multiplexer relates to the odd channels, while that connected to the input B relates to the even ones.

The parallel-connected outputs of the analog multiplexer are amplified by the fast operational amplifier which has also the function of shifting the ADC baseline by adding a DC level. The external DAC (VDAC control signal) allows to set this baseline correctly, according to the type of signal to be converted. The operational amplifier has as well a capacitor which can be used for limiting the bandwidth in order to reduce the noise, although this implies a deterioration of the cross-talk. This can be done via hardware by soldering a capacitor on the printed board (capacitor C_{BL} on the printed board; please refer to Fig. 4.1).

The ADC is a 10-bit 20-MHz converter with external references.

The third section is the digital one and comprehends the digital multiplexers, the control logic and the output link.

The control logic, hosted in a PAL device (MAX7032-15), generates the multiplexing and digitizing signals which are sent through the digital multiplexer to the input of the 40-MHz serial link.

The external control signals accepted by the module are VDAC, +TPULSE, -TPULSE, TPE_EN, TPO_EN, B_CLK, /B_CLK and EN_BRD.

The VDAC control signal allows to set the baseline to be added to the input of the fast operational amplifier, according to the type of signal to be converted.

The differential test pulse (+TPULSE and -TPULSE signals) comes from the backplane. The signal coming from the backplane has to be attenuated by a factor 10 before being sent to the preamplifiers.

The TPE_EN and TPO_EN signals allow to enable the test pulsing on the even and odd channels, respectively. Since the test pulse is directly connected to the input of the preamplifiers, when the test pulse is not used, it is necessary to connect it to ground through a very low impedance by disabling the TPE_EN and TPO_EN signals.

The differential clock signal (B_CLK and /B_CLK) is the external clock used to synchronise all the V791 modules in the crate. The selection of the clock, external or internal, can be made by means of a soldering (soldering pad S2 on the printed board; please refer to Fig. 4.1). The external clock is the default setting.

The EN_BRD logic signal is used to force the control logic in the reset state and, consequently, to stop the digitization of the signals.

All these control signals are sent to the board via the relevant pins of the power supply connector.

Moreover, a further output signal (RTXPWS) of the output connector *Link Conn* has been foreseen to supply +5 V to a possible, external optical decoupler used to break the ground loop. This can be done by making a solder on an appropriate pad in the printed board (S1 soldering pad, please refer to Fig. 4.1).

The output serial link features a 21-bit data word which is composed as follows:

- 10-bit ADC datum coming, in turn, from one of the channels 0-15;
- 10-bit ADC datum coming, in turn, from one of the channels 16-31;
- 1-bit SYNC datum for the synchronisation of the signals.

The transmission sequence is such that each couple of 10-bit ADC data is relative to the channels n and $n + 16$, with n running from 0 to 15. The SYNC bit is set to 1 in correspondence with the couple of ADC data relative to the channels 15 and 31.

3. Technical Specifications

3.1. Packaging

The board is housed in a 1-unit wide, 6-unit high Eurocard standard mechanics.

The front panel of the Model V791 is shown in Fig. 3.2.

The module hosts four external connectors:

<i>rear part of the module:</i>	64-pin input connector; 30-pin power supply and auxiliary signal connector;
<i>front panel:</i>	serial link output connector (Link Conn); Σ out output connector.

Fig. 3.1 shows the location of the connectors on the board and the three main functional sections:

- preamplifier and shaper section,
- ADC and analog multiplexer section,
- digital section.

Please note that, although the module is housed in a Eurocard standard mechanics, the rear connectors are not VME standard connectors since the backplane for which the board has been designed is proprietary.

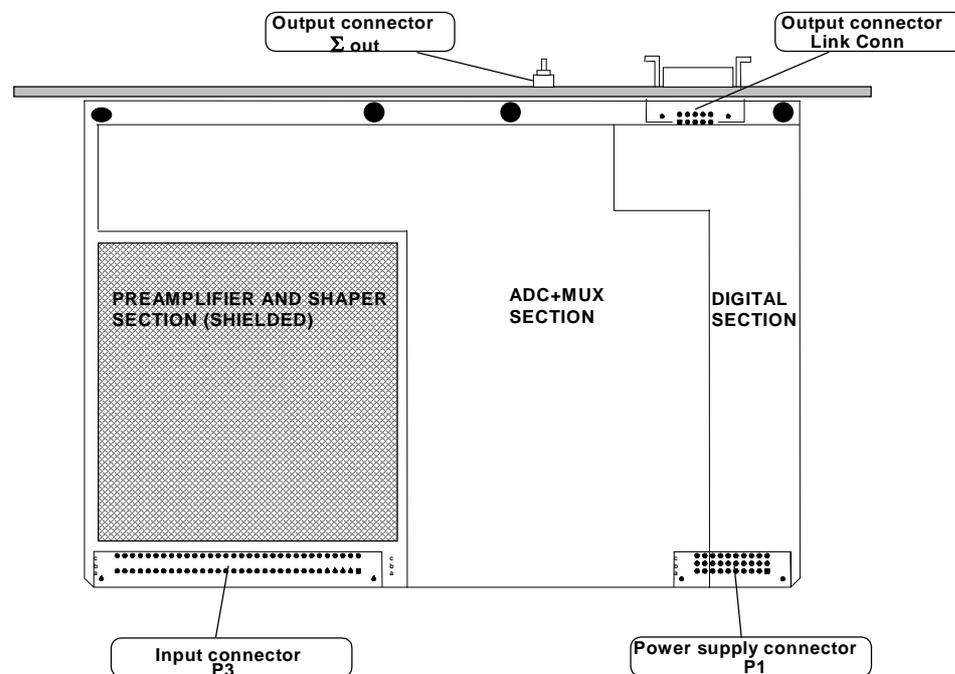


Fig. 3.1 - Model V791 board and connectors

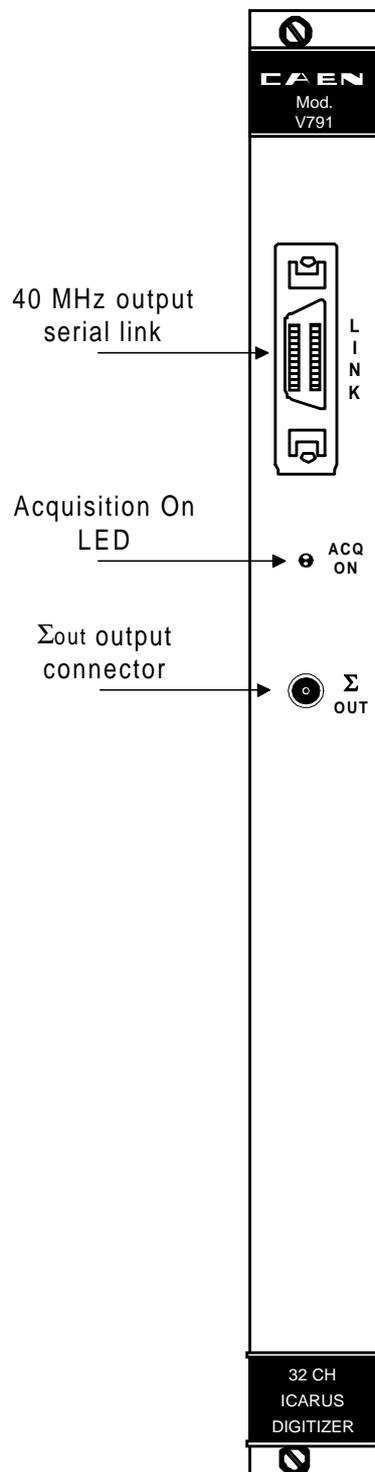


Fig. 3.2 - Front panel of the Model V791

3.2. Power Requirements

The power requirements of the board are:

Table 3.1 - Power requirements

<i>Power Supply</i>	<i>Section</i>	<i>Absorption (max)</i>
+5 V	analog	1 A
+5 V	digital	1.2 A
-5 V	analog	0.25 A

The crate must have a low-noise linear power supply with separate analog and digital supply sections. It is suggested the use of a π -filter regulator for the analog section.

The board has three common terminals: AGND, AGND1, DGND. AGND refers to the preamplifiers, AGND1 refers to the analog multiplexers, shapers and ADCs and DGND is the common terminal of the digital section. **The Σ out output signal is referred to the AGND1 common terminal.**

3.3. External connections

The external connection pin configurations of the V791 module are shown in Fig. 3.3, while their function and electro-mechanical specifications are listed in the following sections.

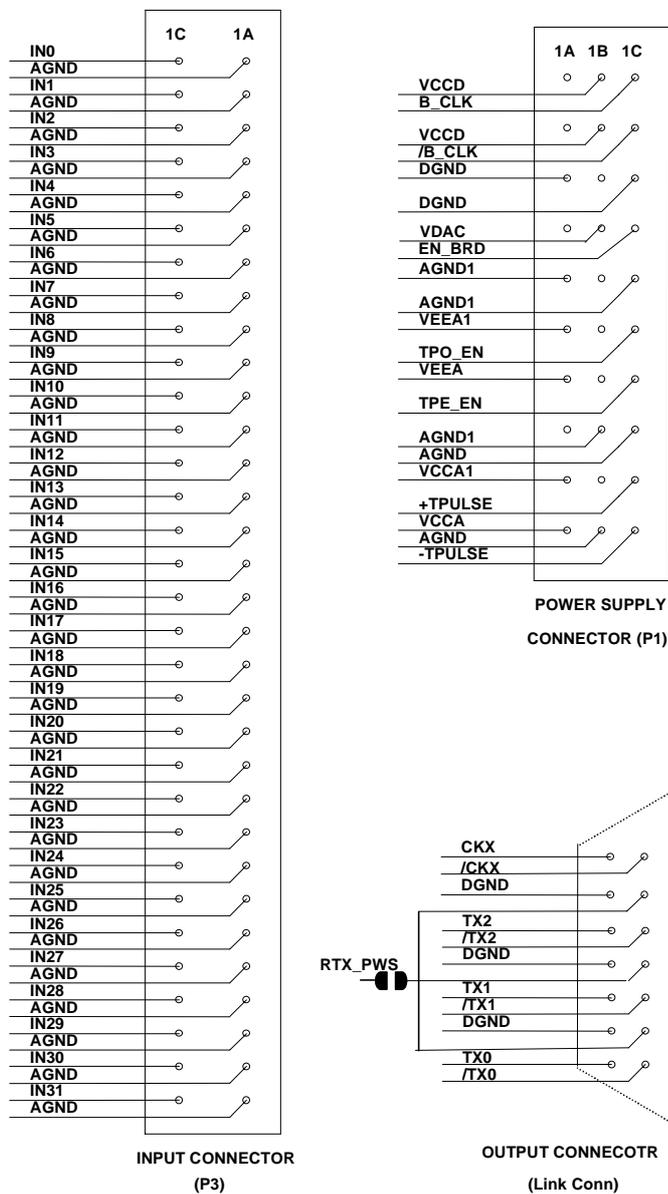


Fig. 3.3 - Pin configuration of the connectors on the Model V791

3.3.1. INPUTS

INPUT CONNECTOR (P3)

Mechanical specifications:

64-pin, C-type, A/C lines, DIN41612 standard connector;

Electrical specifications:

- **AIN0..AIN31:** analog inputs referring to the channels 0..31;
- **AGND:** common terminal of the analog inputs.

POWER SUPPLY CONNECTOR (P1)

Mechanical specifications:

30-pin, C-type, A/B/C lines, DIN41612 standard connector;

Electrical specifications:

- **VCCD:** +5V for the digital section;
- **VCCA:** +5V for the preamplifiers;
- **VCCA1:** +5V for the shapers and the analog multiplexer and ADC section;
- **VEEA:** -5V for the preamplifier;
- **VEEA1:** -5V for the analog multiplexer and shapers;
- **DGND:** common terminal of the digital section;
- **AGND:** common terminal of the preamplifiers;
- **AGND1:** common terminal of the shapers, analog multiplexers and ADCs;
- **B_CLK:** 40 MHz clock coming from the backplane, differential LVDS;
- **/B_CLK:** 40 MHz clock coming from the backplane, differential LVDS, inverted phase;
- **VDAC:** setting voltage of the baseline (in the range ± 2.5 V);
- **TPO_EN:** test pulse enable for the odd channels, TTL;
- **TPE_EN:** test pulse enable for the even channels, TTL;
- **TPULSE:** test pulse signal; this signal must be trapezoidal and have edge amplitude and width so as to inject the desired current through a 1-pF capacitor after a 1:11-attenuation. Optionally, the test signal can be generated externally according to the test method used in the experiment;
- **-TPULSE:** test pulse signal, inverted phase;
- **EN_BRD:** as long as it is high, the V791 Logic is forced in the reset state, TTL.

3.3.2. OUTPUTS

OUTPUT CONNECTOR (LINK CONN)

Mechanical specifications:

N102145212JL-type, Mini D ribbon connector.

Electrical specifications:

- **TX0..TX2:** data output of the digital link;
- **/TX0../TX2:** data output of the digital link, inverted phase;
- **CKX:** clock output of the digital link;
- **/CKX:** clock output of the digital link, inverted phase;
- **DGND:** common terminal for the digital link outputs;
- **RTXPWS:** power supply for a possible optical decoupler.

ANALOG ADDER OUTPUT CONNECTOR (Σ OUT)

Mechanical specifications:

SMB connector.

Electrical specifications:

- **Σ OUT:** sum of the outputs of all the shapers.

WARNING: the Σ out output signal is referred to the shaper ground (AGND1) and, consequently, the user must be very careful to avoid ground loops.



CAUTION

Σ OUT IS REFERRED TO THE SHAPER GROUND (AGND1 COMMON TERMINAL)

AND CONSEQUENTLY, IF Σ OUT IS USED,

THE USER MUST BE VERY CAREFUL TO AVOID GROUND LOOPS!

3.4. Displays

ACQ ON:

Colour: red.

Function: it lights up during data acquisition.

4. Hardware settings

The hardware settings described in the following are foreseen for both the versions, nominally the **Mod.V791C** and the **Mod.V791Q**.

Selection of the clock source (external/internal):

it is performed by using the relevant soldering jumper pad (S2) placed on the PCB (refer to Fig. 4.1):

- Soldering placed in Position A (high position, EXT): → external clock selected;
- Soldering placed in Position B (low position, INT): → internal clock selected.

The default setting is external clock.

Generation of the RTXPWS power supply:

the RTXPWS output signal is used to supply +5 V to a possible external optical decoupler which can be used to break the ground loop. The RTXPWS power supply is provided at the relevant pin of the output connector (LINK CONN) when a soldering is performed on the relevant soldering pad (S1) placed on the PCB (refer to Fig. 4.1):

- No Soldering: → no RTXPWS power supply on the LINK connector;
- Soldering on the S2 pad: → the RTXPWS power supply is present on the relevant pin of the LINK connector.

By default there is no soldering on the S2 pad.

Limitation of the Op-Amp bandwidth:

the PCB houses four empty pads (refer to Fig. 4.1), one for each Op-Amp, which allow to solder an additional capacitor C_{BL} to reduce the bandwidth of the relevant Op-Amp:

- No C_{BL} capacitor: → default Op-Amp bandwidth;
- C_{BL} capacitor soldered on the pad: → the bandwidth of the relevant Op-Amp is reduced.

By default there is no capacitor soldered on the pad.

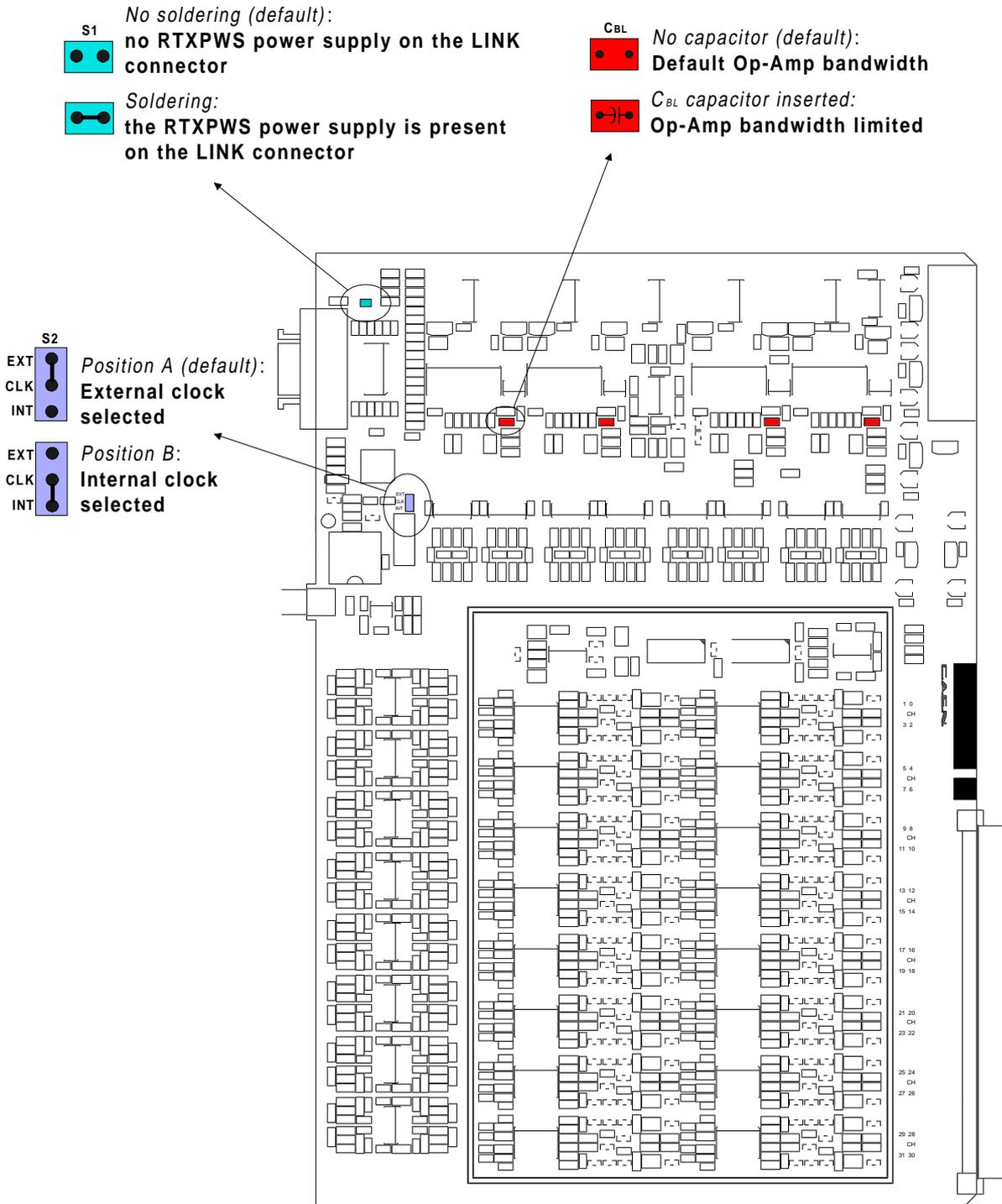


Fig. 4.1 - Component location on the Model V791 board

5. Output data

The data at the serial link output are 21-bit words and are structured as follows (refer to Fig. 5.1):

- 10 bits containing the ADC datum of the channel n,
- 10 bits containing the ADC datum of the channel n + 16,
- 1 bit containing the SYNC signal,

with n running from 0 to 15.

The SYNC bit (Bit 20 in the figure) is set to 1 in correspondence with the couple of ADC data relative to the channels 15 and 31 (n = 15).

Bit 20	Bits 19...10	Bits 9...0
0	CHANNEL 16	CHANNEL 0
0	CHANNEL 17	CHANNEL 1
0	CHANNEL 18	CHANNEL 2
0	CHANNEL 19	CHANNEL 3
0	CHANNEL 20	CHANNEL 4
0	CHANNEL 21	CHANNEL 5
0	CHANNEL 22	CHANNEL 6
0	CHANNEL 23	CHANNEL 7
0	CHANNEL 24	CHANNEL 8
0	CHANNEL 25	CHANNEL 9
0	CHANNEL 26	CHANNEL 10
0	CHANNEL 27	CHANNEL 11
0	CHANNEL 28	CHANNEL 12
0	CHANNEL 29	CHANNEL 13
0	CHANNEL 30	CHANNEL 14
1	CHANNEL 31	CHANNEL 15

Fig. 5.1 - Format of the output data packet